



SANYO Semiconductors

DATA SHEET

STK433-090-E — Thick-Film Hybrid IC 2-channel class AB audio power IC, 80W+80W

Overview

The STK433-090-E is a hybrid IC designed to be used in 80W × 2ch class AB audio power amplifiers.

Applications

- Audio power amplifiers.

Features

- Pin-to-pin compatible outputs ranging from 80W to 150W.
- Can be used to replace the STK433-000 series (30W to 60W/2ch) and STK433-200/-300 series (3-channel) due to its pin compatibility.
- Miniature package (67.0mm × 25.6mm × 9.0mm)
- Output load impedance: $R_L = 6\Omega$ supported
- Allowable load shorted time: 0.3 second
- Allows the use of predesigned applications for standby and mute circuits.

Series Models

	STK433-090-E	STK433-100-E	STK433-120-E	STK433-130-E
Output 1 (10%/1kHz)	80W×2 channels	100W×2 channels	120W×2 channels	150W×2 channels
Output 2 (0.4%/20Hz to 20kHz)	50W×2 channels	60W×2 channels	80W×2 channels	100W×2 channels
Max. rated V_{CC} (quiescent)	±54V	±57V	±65V	±71.5V
Max. rated V_{CC} (6Ω)	±47V	±50V	±57V	±63V
Recommended operating V_{CC} (6Ω)	±33V	±35V	±40V	±44V
Dimensions (excluding pin height)	67.0mm×25.6mm×9.0mm			

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Specifications

Absolute maximum ratings at Ta=25°C (excluding rated temperature items), Tc=25°C unless otherwise specified

Parameter	Symbol	Conditions	Ratings	Unit
Maximum quiescent supply voltage 0	V _{CC} max (0)	When no signal	±54	V
Maximum supply voltage 1	V _{CC} max (1)	R _L ≥ 6Ω	±47	V
Minimum operating supply voltage	V _{CC} min		±10	V
Maximum operating flow-in current (pin 13) *7	IST OFF max		0.6	mA
Thermal resistance	θj-c	Per power transistor	2.1	°C/W
Junction temperature	Tj max	Both the Tj max and Tc max conditions must be met.	150	°C
IC substrate operating temperature	Tc max		125	°C
Storage temperature	Tstg		-30 to +125	°C
Allowable load shorted time *4	ts	V _{CC} =±33V, R _L =6Ω, f=50Hz, P _O =50W, 1-channel active	0.3	s

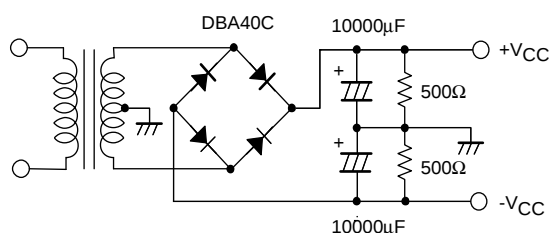
Operating Characteristics at Tc=25°C, R_L=6Ω, Rg=600Ω, VG=30dB, non-inductive load R_L, unless otherwise specified

Parameter	Symbol	Conditions *2					Ratings			unit
		V _{CC} (V)	f (Hz)	P _O (W)	THD (%)		min	typ	max	
Output power *1	P _O (1)	±33	20 to 20k		0.4		47	50		W
	P _O (2)	±33	1k		10			80		
Total harmonic distortion *1	THD (1)	±33	20 to 20k	5.0		VG=30dB			0.4	%
	THD (2)	±33	1k					0.01		
Frequency characteristics *1	f _L , f _H	±33		1.0		+0 -3dB	20 to 50k			Hz
Input impedance	ri	±33	1k	1.0				55		kΩ
Output noise voltage *3	V _{NO}	±39				Rg=2.2kΩ			1.0	mVrms
Quiescent current	I _{CCO}	±39				No loading	20	45	80	mA
Output neutral voltage	V _N	±39					-70	0	+70	mV
Current flowing into pin13 in standby mode *7	IST ON	±33				Voltage at pin13: 5V, Current limiting resistance R1: 13kΩ			0	mA
Current flowing into pin13 in operating mode *7	IST OFF	±33					0.25		0.6	mA

[Remarks]

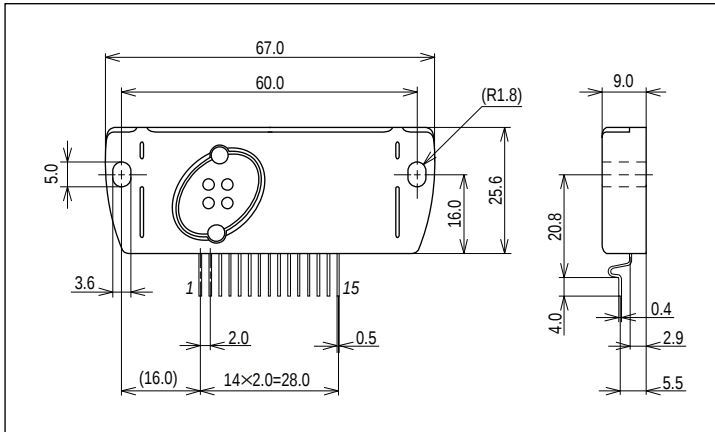
- *1: For 1-channel operation
- *2: Unless otherwise specified, use a constant-voltage power supply to supply power when inspections are carried out.
- *3: The output noise voltage values shown are peak values read with a VTVM. However, an AC stabilized (50Hz) power supply should be used to minimize the influence of AC primary side flicker noise on the reading.
- *4: Use the designated transformer power supply circuit shown in the figure below for the measurement of allowable load shorted time and output noise voltage.
- *5: Please connect -Pre V_{CC} pin (#1 pin) with the stable minimum voltage and connect so that current does not flow in by reverse bias.
- *6: Thermal design must be implemented based on the conditions under which the customer's end products are expected to operate on the market.
- *7: Be sure to use the current limiting resistor to prevent the current flowing into the standby pin (pin13) never exceeds the maximum rated value in operating mode.
The circuit is turned on by applying VBE (approximately 0.6V) or higher voltage to the standby pin (pin13).
- *8: A thermoplastic adhesive resin is used for this hybrid IC.

Designated transformer power supply (MG-200 equivalent)

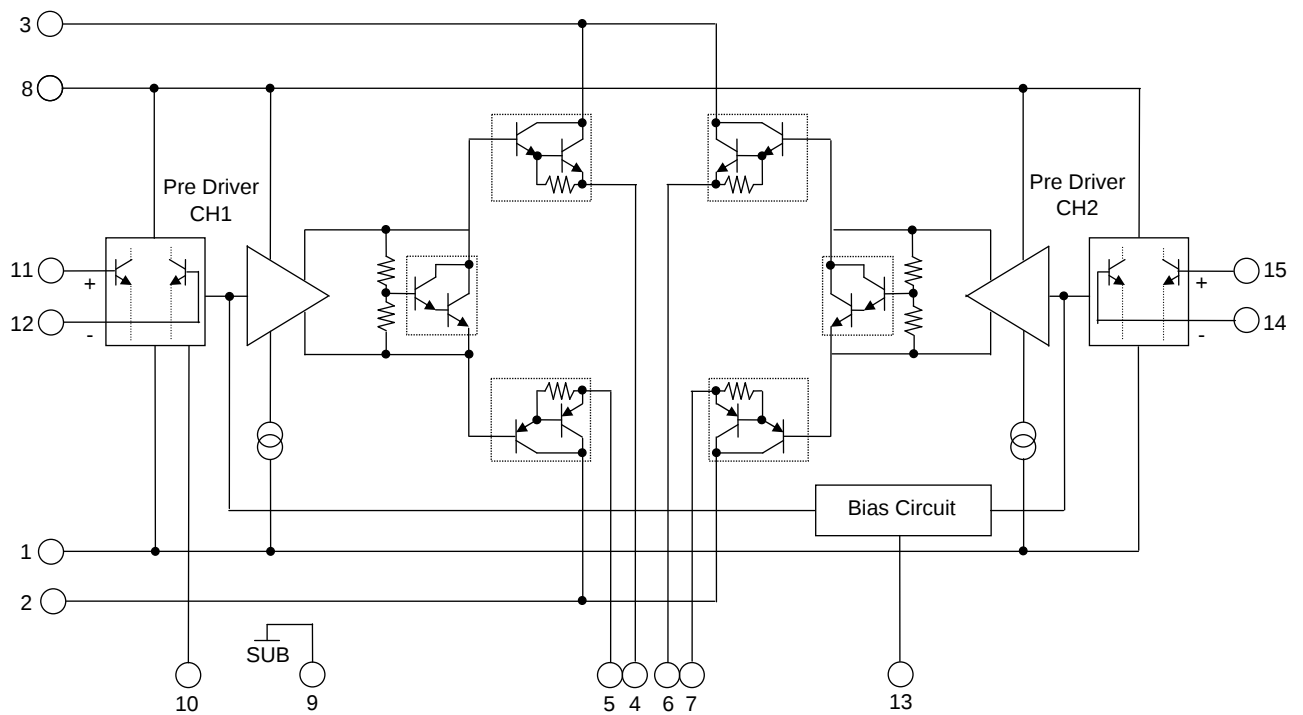


Package Dimensions

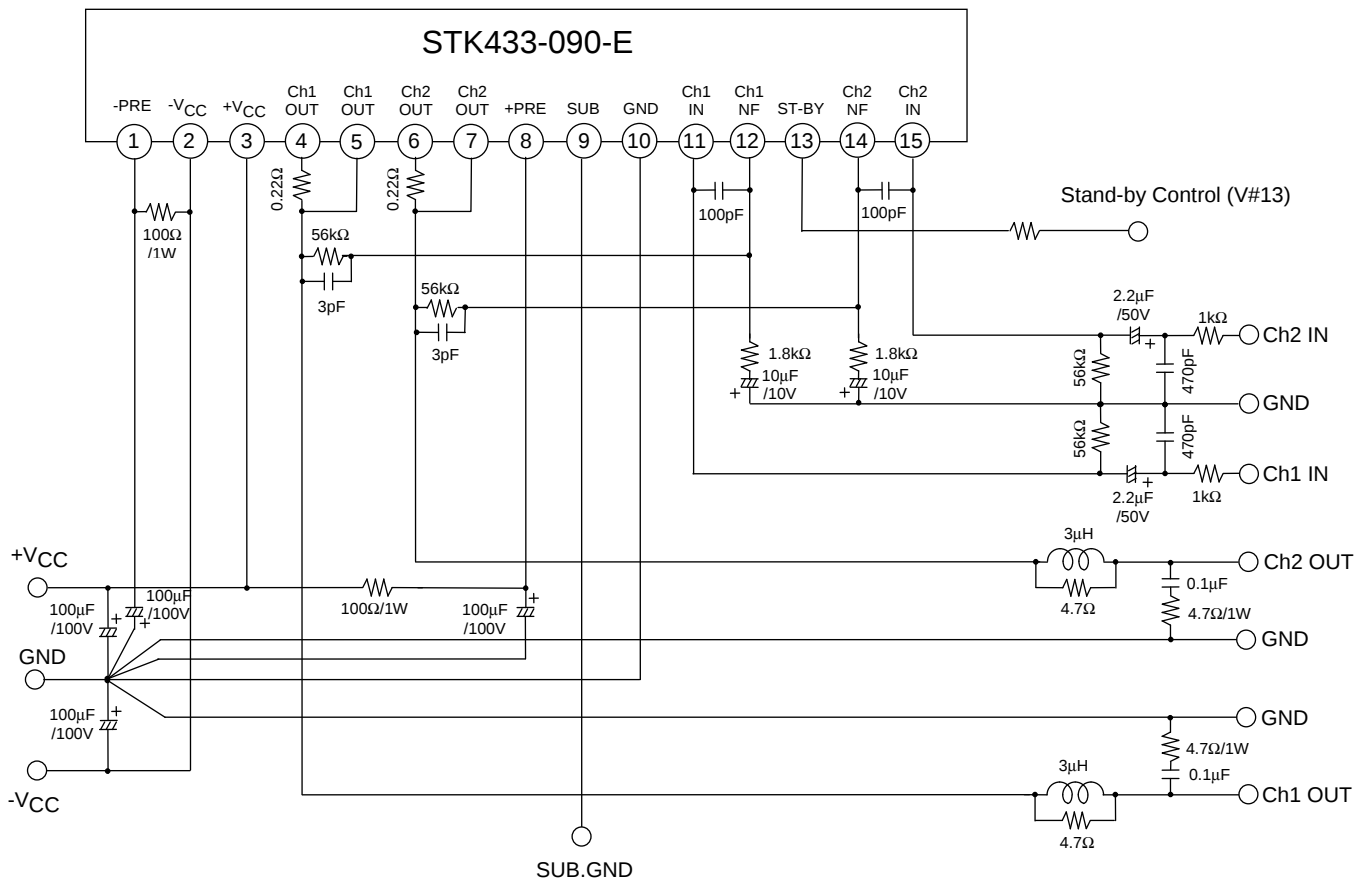
unit:mm (typ)



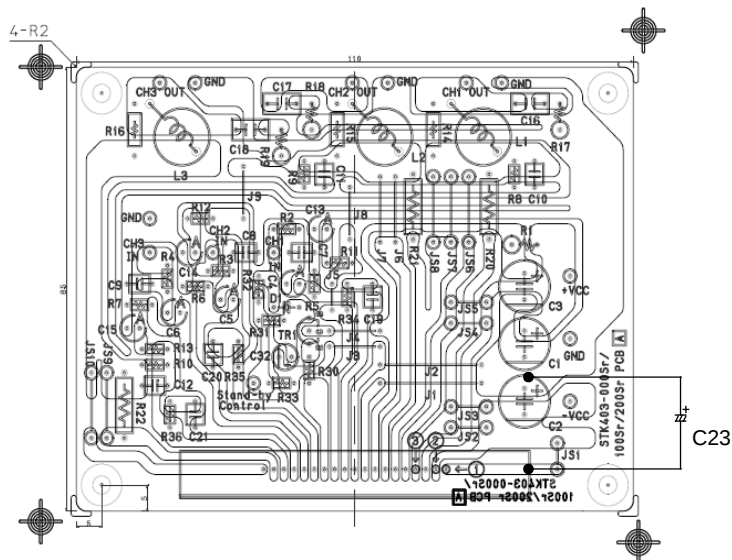
Internal Equivalent Circuit



Application Circuit Example



Sample PCB Trace Pattern



STK433-100/STK433-300Sr PCB PARTS LIST

PCB Name: STK403-000Sr/100Sr/200Sr PCBA

Location No. * 2ch AMP doesn't mount parts of ().		PARTS	RATING	Component	
Hybrid IC#1 Pin Position		-	-	①	
				STK433-100Sr (*2)	STK433-300Sr
R01		ERG1SJ101	100Ω,1W	enabled	
R02, R03 (R4)		RN16S102FK	1kΩ, 1/6W	enabled	
R05, R06, R08, R09 (R7, R10)		RN16S563FK	56kΩ, 1/6W	enabled	
R11, R12 (R13)		RN16S182FK	1.8kΩ, 1/6W	enabled	
R14, R15 (R16)		RN14S4R7FK	4.7Ω, 1/4W	enabled	
R17, R18 (R19)		ERX1SJ4R7	4.7Ω, 1W	enabled	
R20, R21 (R22)		ERX2SJR22	0.22Ω, 2W	enabled	
C01, C02, C03, C23 (*3)		100MV100HC	100μF, 100V	enabled	
C04, C05 (C06)		50MV2R2HC	2.2μF, 50V	enabled (*1)	
C07, C08 (C09)		DD104-63B471K50	470pF, 50V	enabled	
C10, C11 (C12)		DD104-63CJ030C50	3pF, 50V	enabled	
C13, C14 (C15)		10MV10HC	10μF, 10V	enabled (*1)	
C16, C17 (C18)		ECQ-V1H104JZ	0.1μF, 50V	enabled	
C19, C20 (C21)		DD104-63B***K50	***pF, 50V	100pF	68pF
R34, R35 (R36)		RN16S302FK	3kΩ, 1/6W	Short	
L01, L02 (L3)		-	3μH	enabled	
Stand-By Control Circuit	Tr1	2SC3332 (Reference)	$V_{CE} \geq 75V, I_C \geq 1mA$	enabled	
	D1	GMB01 (Reference)	Di	enabled	
	R30	RN16S***FK	***kΩ, 1/6W	13kΩ	2.7kΩ
	R31	RN16S333FK	33kΩ, 1/6W	enabled	
	R32	RN16S102FK	1kΩ, 1/6W	enabled	
	R33	RN16S202FK	2kΩ, 1/6W	enabled	
	C32	10MV33HC	33μF, 10V	enabled	
J1, J2, J3, J4, J5, J6, J8, J9		-	-	enabled	
J7, JS2, JS3, JS4, JS5, JS7 JS8, JS9		-	-	-	
JS6, JS10		-	-	enabled	
JS1		ERG1SJ101	100Ω, 1W	enabled	

(*1) Capacitor mark “A” side is “-” (negative).

(*2) STK433-100Sr (2ch AMP) doesn't mount parts of ().

(*3) Add parts C23 to the other side of PCB.

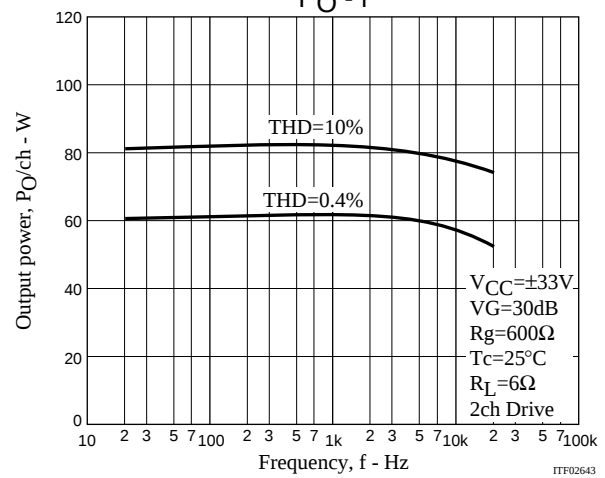
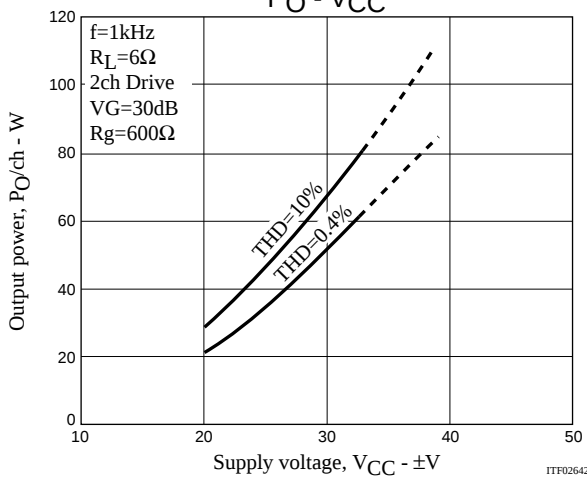
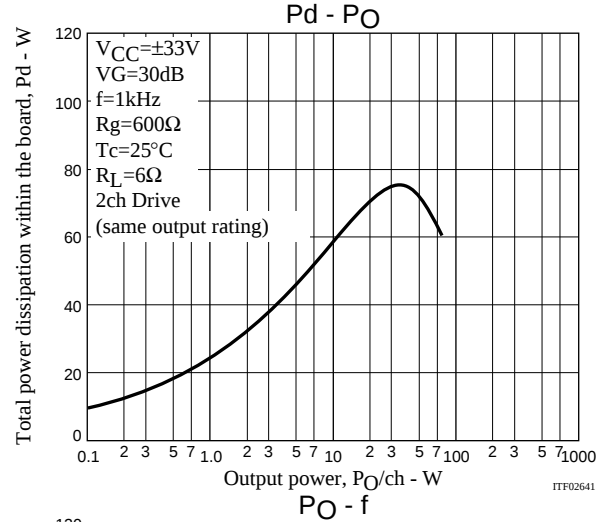
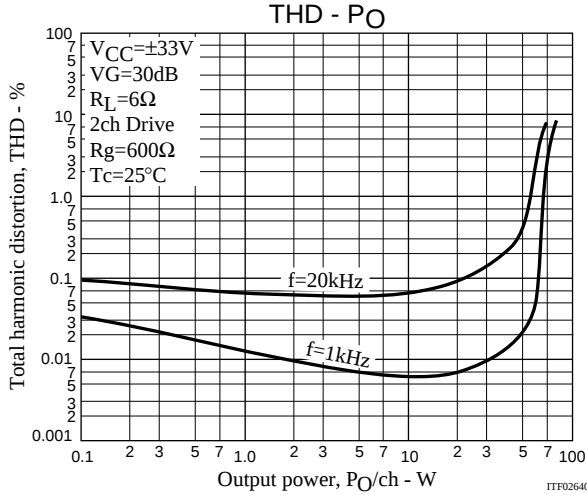
STK433-090-E

Pin Assignments

[STK433-000/-100/-200Sr & STK415/416-100Sr Pin Layout]

2ch class-AB																																		
	2ch classAB/2.00mm																																	
STK433-030-E 30W/JEITA STK433-040-E 40W/JEITA STK433-060-E 50W/JEITA STK433-070-E 60W/JEITA STK433-090-E 80W/JEITA STK433-100-E 100W/JEITA STK433-120-E 120W/JEITA STK433-130-E 150W/JEITA		- P R E	- V C C	+ V C C	O U T / C H 1	O U T / C H 1	O U T / C H 2	O U T / C H 2	+	P R E	S U B • G N D	G N D	I N / C H 1	N F / C H 1	S T A N D B Y	N F / C H 2	I N / C H 2																	
3ch class-AB																1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
	3ch classAB/2.00mm																																	
STK433-230A-E 30W/JEITA STK433-240A-E 40W/JEITA STK433-260A-E 50W/JEITA STK433-270-E 60W/JEITA STK433-290-E 80W/JEITA STK433-300-E 100W/JEITA STK433-320-E 120W/JEITA STK433-330-E 150W/JEITA		- P R E	- V C C	+ V C C	O U T / C H 1 +	O U T / C H 1 -	O U T / C H 2 +	O U T / C H 2 -	+	P R E	S U B • G N D	G N D	I N / C H 1	N F / C H 1	S T A N D B Y	N F / C H 2	I N / C H 2	I N / C H 3	N F / C H 3	O U T / C H 3 +	O U T / C H 3 -													
2ch class-H	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19															
	2ch classH/2.00mm																																	
STK415-090-E 80W/JEITA STK415-100-E 90W/JEITA STK415-120-E 120W/JEITA STK415-130-E 150W/JEITA STK415-140-E 180W/JEITA	+	- V L	+	- O F S E T	- O F S E T	- P R E	- V H	+	V H	O U T / C H 1 +	O U T / C H 1 -	O U T / C H 2 +	O U T / C H 2 -	+	P R E	S U B • G N D	G N D	I N / C H 1	N F / C H 1	S T A N D B Y	N F / C H 2	I N / C H 2												
3ch class-H	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23											
	3ch classH/2.00mm																																	
STK416-090-E 80W/JEITA STK416-100-E 90W/JEITA STK416-120-E 120W/JEITA STK416-130-E 150W/JEITA	+	- V L	+	- O F S E T	- O F S E T	- P R E	- V H	+	V H	O U T / C H 1 +	O U T / C H 1 -	O U T / C H 2 +	O U T / C H 2 -	+	P R E	S U B • G N D	G N D	I N / C H 1	N F / C H 1	S T A N D B Y	N F / C H 2	I N / C H 2	I N / C H 3	N F / C H 3	O U T / C H 3 +	O U T / C H 3 -								

Evaluation Board Characteristics



[Thermal Design Example for STK433-090-E ($R_L = 6\Omega$)]

The thermal resistance, θ_{c-a} , of the heat sink for total power dissipation, P_d , within the hybrid IC is determined as follows.

Condition 1: The hybrid IC substrate temperature, T_c , must not exceed $125^\circ C$.

$$P_d \times \theta_{c-a} + T_a < 125^\circ C \quad (1)$$

T_a : Guaranteed ambient temperature for the end product

Condition 2: The junction temperature, T_j , of each power transistor must not exceed $150^\circ C$.

$$P_d \times \theta_{c-a} + P_d/N \times \theta_{j-c} + T_a < 150^\circ C \quad (2)$$

N : Number of power transistors

θ_{j-c} : Thermal resistance per power transistor

However, the power dissipation, P_d , for the power transistors shall be allocated equally among the number of power transistors.

The following inequalities result from solving equations (1) and (2) for θ_{c-a} .

$$\theta_{c-a} < (125 - T_a)/P_d \quad (1)'$$

$$\theta_{c-a} < (150 - T_a)/P_d - \theta_{j-c}/N \quad (2)'$$

Values that satisfy these two inequalities at the same time represent the required heat sink thermal resistance.

When the following specifications have been stipulated, the required heat sink thermal resistance can be determined from formulas (1)' and (2)'.

- Supply voltage V_{CC}
- Load resistance R_L
- Guaranteed ambient temperature T_a

[Example]

When the IC supply voltage, V_{CC} , is $\pm 33V$ and R_L is 6Ω , the total power dissipation, P_d , within the hybrid IC, will be a maximum of $75W$ at $1kHz$ for a continuous sine wave signal according to the P_d - P_O characteristics.

For the music signals normally handled by audio amplifiers, a value of $1/8P_O$ max is generally used for P_d as an estimate of the power dissipation based on the type of continuous signal. (Note that the factor used may differ depending on the safety standard used.)

This is:

$$P_d \approx 59.0W \quad (\text{when } 1/8P_O \text{ max.} = 10W, P_O \text{ max.} = 80W).$$

The number of power transistors in audio amplifier block of these hybrid ICs, N , is 4, and the thermal resistance per transistor, θ_{j-c} , is $2.1^\circ C/W$. Therefore, the required heat sink thermal resistance for a guaranteed ambient temperature, T_a , of $50^\circ C$ will be as follows.

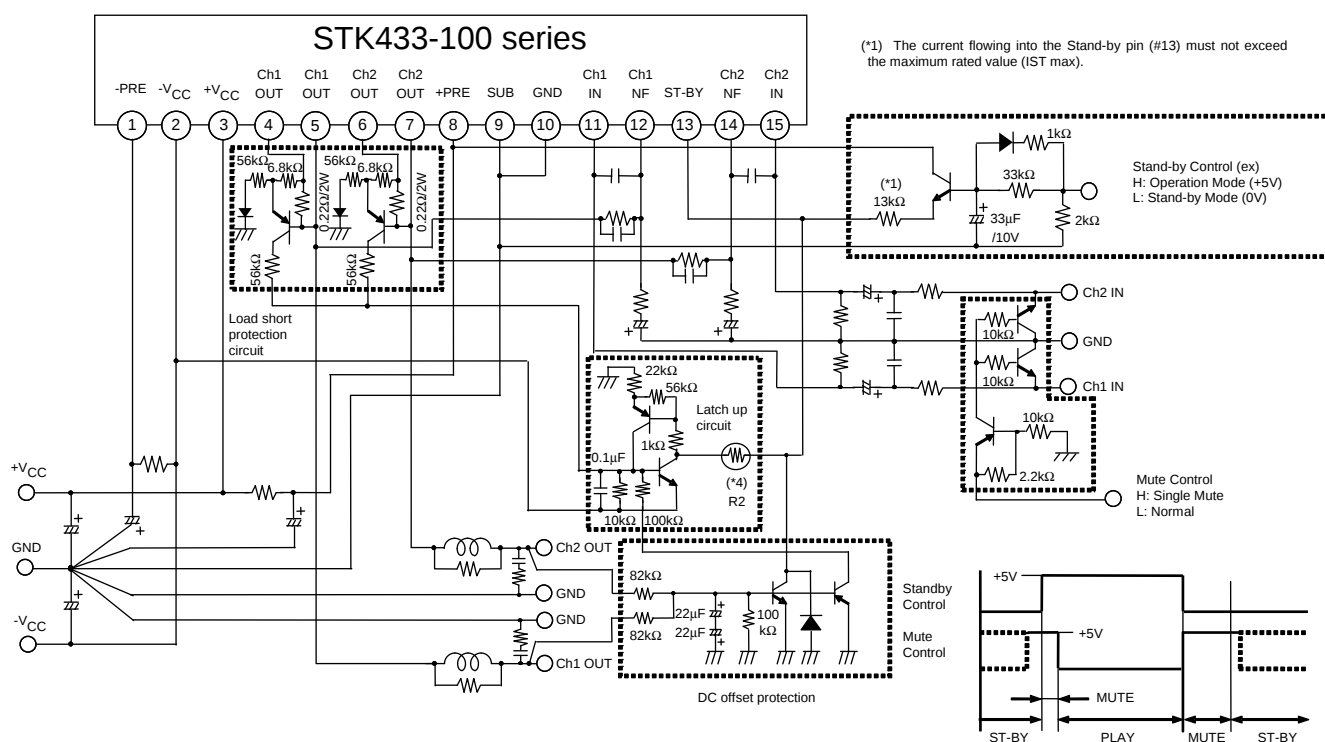
$$\begin{aligned} \text{From formula (1)'} \quad \theta_{c-a} &< (125 - 50)/59.0 \\ &< 1.27 \end{aligned}$$

$$\begin{aligned} \text{From formula (2)'} \quad \theta_{c-a} &< (150 - 50)/59.0 - 2.1/4 \\ &< 1.17 \end{aligned}$$

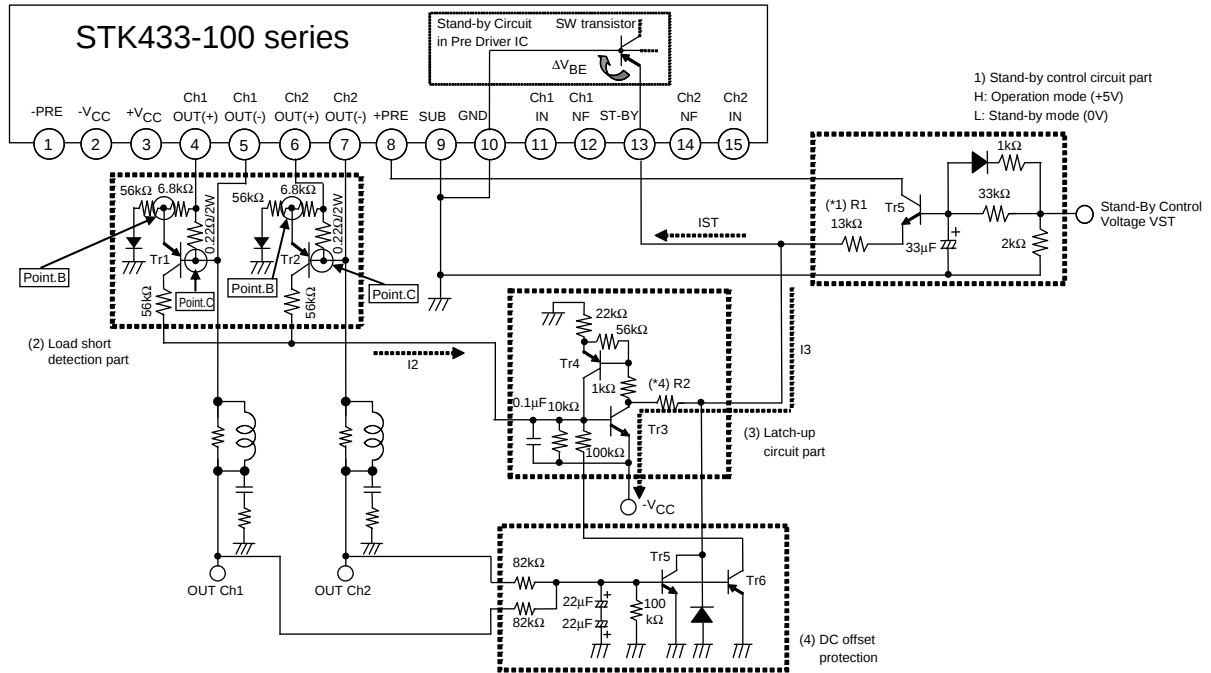
Therefore, the value of $1.17^\circ C/W$, which satisfies both of these formulae, is the required thermal resistance of the heat sink.

Note that this thermal design example assumes the use of a constant-voltage power supply, and is therefore not a verified design for any particular user's end product.

STK433-100 Series Standby Control, Mute Control, Load-short Protection & DC offset Protection application



STK433-100 Series Application Explanation

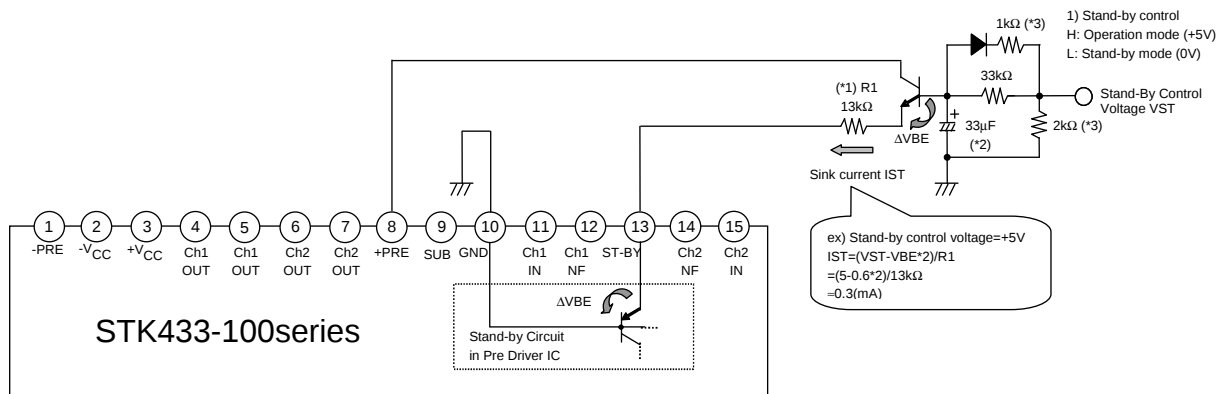


The protection circuit application for the STK433-100sr consists of the following blocks (blocks (1) to (4)).

- (1) Standby control circuit block
- (2) Load short-circuit detection block
- (3) Latch-up circuit block
- (4) DC voltage protection block

1) Standby control circuit block

(Reference example) STK433-100 series test circuit (when +5V is applied to Stand-by control.)



Concerning pin 13 reference voltage VST

<1> Operation mode

The switching transistor in the bias circuit turns on and places the amplifier into the operating mode when the current flowing into pin 13 (IST) becomes 0.25mA or greater.

<2> Standby mode

When the current flowing into pin 13 (IST) is stopped (=0mA), the switching transistor in the bias circuit turns off, placing the amplifier into the standby mode.

(*1) The current limiting resistor (R1) must be used to ensure that the current flowing into the stand-by pin (pin 13) does not exceed its maximum rated value IST max.

(*2) The pop noise level when the power is turned on can be reduced by setting the time constant with a capacitor in operating mode.

(*3) Determines the time constant at which the capacitor (*2) is discharged in standby mode.

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